



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts,Customers Priority,Honest Operation,and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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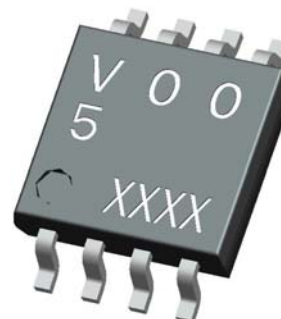


Constant Current IC

W2RV005RM

Most Suitable Constant Current IC for Driving Full Color LED

- Built-in 3 lines required to drive full color LED.
- Easy thermal design due to large power dissipation.
- Contained in the 2.9 x 2.8-mm small package.
- Can be used as a stand-alone IC or can be driven by Omron's W2RF004RM and W2RF002RF LED Control IC's.
- RoHS Compliant



Ordering Information

Description	Model
Constant Current IC	W2RV005RM

Specifications

Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Rating
Supply Voltage	V_{CC}	36 V
Output Voltage	V_{OUT}	36 V
Output Current / terminal	I_{OUT}	50 mA (see note 1)
Input Voltage	V_{IN}	-0.3 to 6 V
Power Dissipation	P_d	IC alone: 387 mW
		Standard Board: 587 mW (see note 2)
Operating Temperature	T_{OPR}	-20 to 85 °C
Storage Temperature	T_{STG}	-40 to 150 °C
Junction Temperature	T_{JMAX}	150 °C

Recommended Operating Conditions

Item	Symbol	Rating
Supply Voltage	V_{CC}	4.5 to 20 V
Output Voltage	V_{OUT}	2.0 to 20 V
Output Current / terminal	I_{OUT}	3.0 to 30 mA

Note: 1. Take the power consumption and power dissipation into consideration.
 2. When implemented on a standard board (70 x 70 x 1.6 mm, Cu 3%, Single-sided glass epoxy board). The value reduces at a rate of about 4.7 mW/°C when the IC is used at Ta = 25°C or higher.

Electrical Characteristics (Ta = 25°C, V_{CC} = 12V)

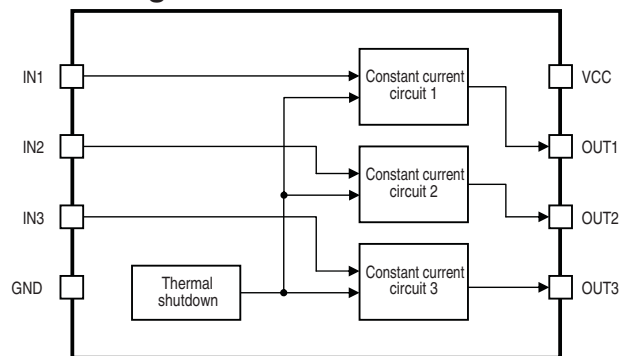
Item	Symbol	Condition	Spec.			Unit	Applicable terminal
			Min.	Typ.	Max.		
Standby current consumption	I_{CC1}	IN1 to 3: OPEN	---	0.7	1.4	mA	V_{CC}
Operating current consumption	I_{CC2}	$R_{IN} = 6.8 \text{ k}\Omega$, $V_{OUT} = 4.0 \text{ V}$, All CH: ON	---	5.5	7.6	mA	V_{CC}
Output current 1	I_{OUT1}	$R_{IN} = 6.8 \text{ k}\Omega$, $V_{OUT} = 4.0 \text{ V}$, All CH: ON	19.5	20.8	22.1	mA	OUT1 to 3
Output current 2	I_{OUT2}	$R_{IN} = 13 \text{ k}\Omega$, $V_{OUT} = 4.0 \text{ V}$, All CH: ON	10.5	11.2	11.9	mA	OUT1 to 3
Current error between channels	ΔI_{OUT}	$R_{IN} = 6.8 \text{ k}\Omega$, $V_{OUT} = 4.0 \text{ V}$	-3.0	---	3.0	%	OUT1 to 3
Output current voltage fluctuation	ΔIV	$R_{IN} = 6.8 \text{ k}\Omega$, $V_{OUT} = 7.0 \pm 4.0 \text{ V}$	-3.0	---	3.0	%	OUT1 to 3
Inverting input current for OFF	I_{OFF}	---	---	---	17.0	μA	IN1 to 3
Inverting input current for ON	I_{ON}	---	42.0	---	---	μA	IN1 to 3
ON output propagation time	t_{ON}	$R_{IN} = 6.8 \text{ k}\Omega$, $V_{OUT} = 4.0 \text{ V}$, Output current $I_{OUT} \times 0.9$ arrival time	---	1.0	---	μS	IN1 to 3 OUT1 to 3
OFF output propagation time	t_{OFF}	$R_{IN} = 6.8 \text{ k}\Omega$, $V_{OUT} = 4.0 \text{ V}$, Output current $I_{OUT} \times 0.1$ arrival time	---	0.4	---	μS	IN1 to 3 OUT1 to 3

Timing Characteristics (Ta = 25°C, VCC = 12V)

Item	Symbol	Condition	Spec.			Unit	Applicable terminal
			Min.	Typ.	Max.		
ON output propagation time	t_{ON}	$R_{IN} = 6.8\text{ k}\Omega$, $V_{OUT} = 4.0\text{V}$, Output current $I_{OUT} \times 0.9$ arrival time.	---	1.0	---	μS	IN1 to 3 OUT1 to 3
OFF output propagation time	t_{OFF}	$R_{IN} = 6.8\text{ k}\Omega$, $V_{OUT} = 4.0\text{V}$, Output current $I_{OUT} \times 0.1$ arrival time.	---	0.4	---	μS	

Engineering Data

Block Diagram

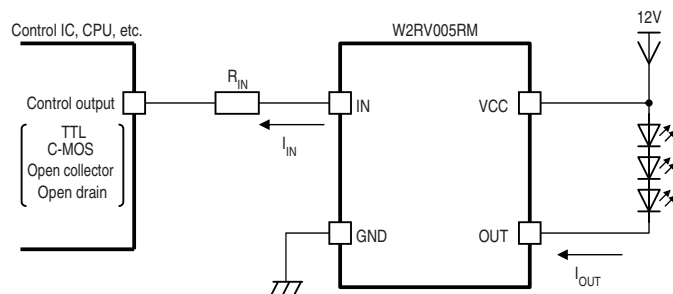


Terminal Designation

Terminal Number	Terminal Name	Description
1	IN1	Input pin 1
2	IN2	Input pin 2
3	IN3	Input pin 3
4	GND	Ground
5	OUT3	Output pin 3
6	OUT2	Output pin 2
7	OUT1	Output pin 1
8	V _{CC}	Power Supply

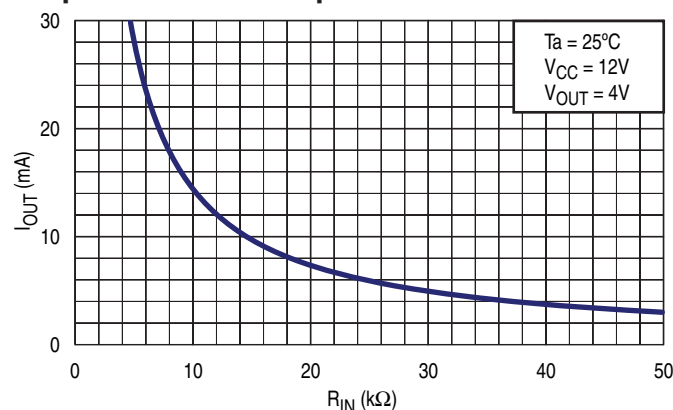
Note: Connect unused input pins to a power supply (voltage equal to V_{CC} or less) like I/O, and leave unused output pins open.

Functions



Control output	Input current I_{IN}	Output current I_{OUT}
Logic H or open	OFF	OFF
Logic L	ON	ON

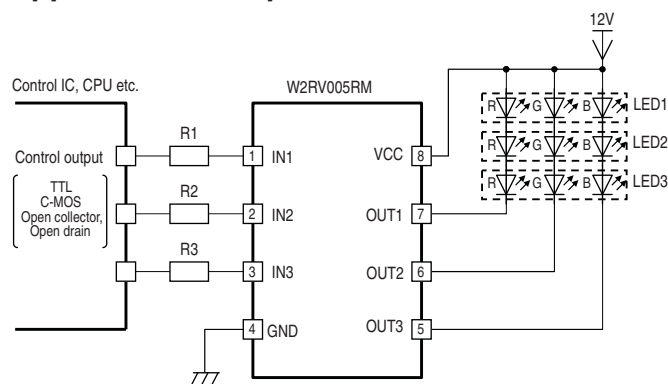
Output Current vs. Input Resistance



Output current I_{OUT} (mA)	Input Resistance R_{IN} (kΩ)
5	29.6
10	14.6
15	9.59
20	7.12
25	5.65
30	4.67

Note: The figures in the table show theoretical values obtained when one end of R_{IN} is connected to GND.

Application Example



Power Consumption Calculation Example

Conditions:

V_F of LED - Red (R): 2.2 V, Green (G): 3.3V, Blue (B): 3.2 V (at 20 mA)

OUT1 ~ 3 are all driven at 20 mA

• Voltage of OUT Terminals

$$\text{OUT1: } 12 - 2.2 \times 3 = 5.4 \text{ V}$$

$$\text{OUT2: } 12 - 3.3 \times 3 = 2.1 \text{ V}$$

$$\text{OUT3: } 12 - 3.2 \times 3 = 2.4 \text{ V}$$

• Power Consumption

$$\text{OUT1: } 5.4 \text{ V} \times 20 \text{ mA} = 108 \text{ mW}$$

$$\text{OUT2: } 2.1 \text{ V} \times 20 \text{ mA} = 42 \text{ mW}$$

$$\text{OUT3: } 2.4 \text{ V} \times 20 \text{ mA} = 48 \text{ mW}$$

$$\text{VCC: } 12 \text{ V} \times 5.5 \text{ mA} = 66 \text{ mW}$$

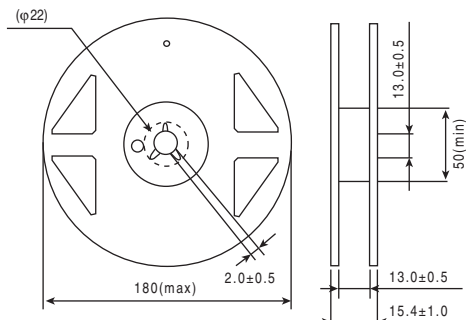
$$\text{Total: } 108 + 42 + 48 + 66 = 264 \text{ mW}$$

Tape Packaging

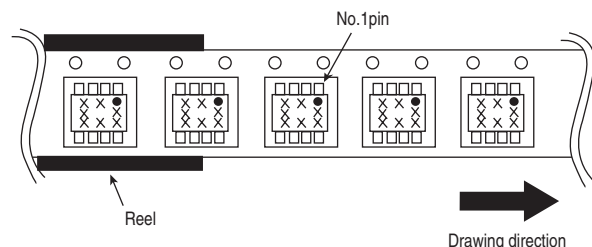
Packaging style: Embossed taping

Packaging quantity: 3,000 pcs/reel

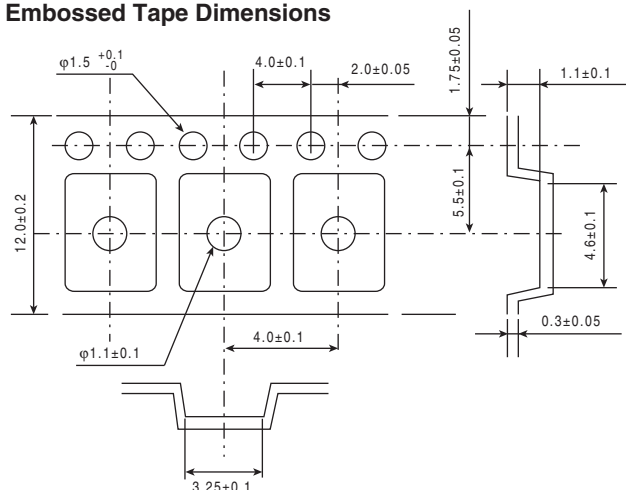
Reel Dimensions



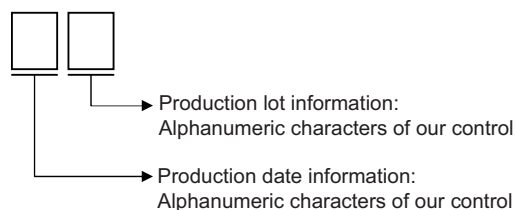
Direction of Insertion



Embossed Tape Dimensions



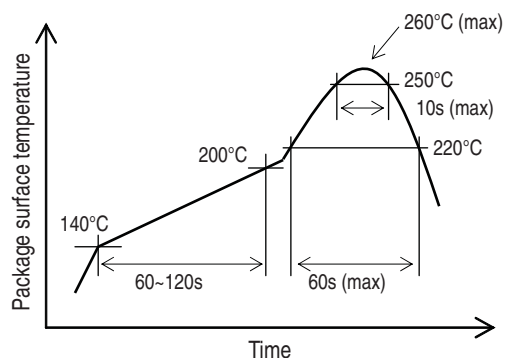
Lot Code Indication



Recommended Reflow Conditions

Allowable Temperature Profile Conditions

Product mounting method should be by Reflow and we recommend the following temperature profile. Reflow no more than two times, maximum.



Storage Conditions before Mounting

Moisture absorption by the plastic package will increase the possibility of faults, such as cracks; therefore, take enough care for storage.

Storage Conditions	Period
5 to 30°C, 40 to 70%RH	One Year



Lead:	1,000 ppm max.
Mercury:	1,000 ppm max.
Cadmium:	100 ppm max.
Hexavalent chromium:	1,000 ppm max.
PBB:	1,000 ppm max.
PBDE:	1,000 ppm max.



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ALL DIMENSIONS SHOWN ARE IN MILLIMETERS.

To convert millimeters into inches, multiply by 0.03937. To convert grams into ounces, multiply by 0.03527.

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